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May 2015

QEE122 / QEE123 Plastic Infrared Light Emitting Diode

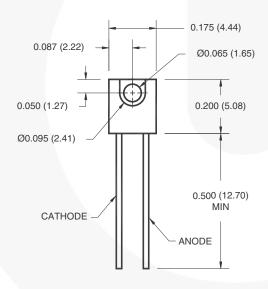
Features

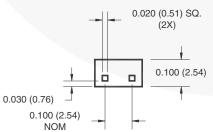
- $\lambda = 880 \text{ nm}$
- Package Type = Sidelooker
- Chip Material = AlGaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- · Package Material: Clear Epoxy
- · High Output Power
- · Orange dot marking on the top side

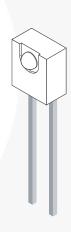
Description

The QEE12X is a 880 nm AlGaAs LED encapsulated in a medium wide angle, plastic sidelooker package.

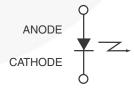
Package Dimensions(1, 2)







Schematic



Notes:

- 1. Dimensions for all drawings are in inches (mm).
- 2. Tolerance of ±0.010 (0.25) on all non-nominal dimensions unless otherwise specified.

1

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter Value		Unit
T _{OPR}	Operating Temperature	-40 to +100	°C
T _{STG}	Storage Temperature	-40 to +100	°C
T _{SOL-I}	Soldering Temperature (Iron) ^(4, 5, 6)	240 for 5 sec	°C
T _{SOL-F}	Soldering Temperature (Flow) ^(4, 5)	260 for 10 sec	°C
I _F	Continuous Forward Current	100	mA
V _R	Reverse Voltage	5	V
P _D	Power Dissipation ⁽³⁾	100	mW

Notes:

- 3. Derate power dissipation linearly 2.67 mW/°C above 25°C.
- 4. RMA flux is recommended.
- 5. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 6. Soldering iron 1/16" (1.6mm) minimum from housing.

Electrical / Optical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
λ _{PE}	Peak Emission Wavelength	I _F = 20 mA		890		nm
TC_λ	Temperature Coefficient			0.2		nm/°C
2Θ ¹ /2	Emission Angle	I _F = 100 mA		50		0
V_{F}	Forward Voltage	$I_F = 100 \text{ mA}, \text{ tp} = 20 \text{ ms}$			1.7	V
TC_{VF}	Temperature Coefficient			-6		mV/°C
I _R	Reverse Current	V _R = 5 V		-/-	10	μΑ
I _E	Radiant Intensity QEE122	$I_{\rm F} = 100 \text{mA}, \text{tp} = 20 \text{ms}$	4	9	16	mW/sr
	Radiant Intensity QEE123	if = 100 mA, tp = 20 ms	8	9	y	11100/51
TC _{IE}	Temperature Coefficient			-0.3		%/°C
t _r	Rise Time	I _F = 100 mA		900		ns
t _f	Fall Time	IF - 100 IIIA		800	19/4	ns
C _j	Junction Capacitance	$V_R = 0 V$		11		pF

Typical Performance Characteristics

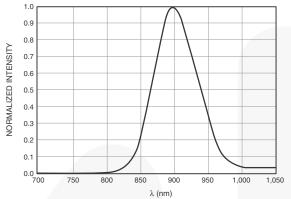


Figure 1. Normalized Intensity vs. Wavelength

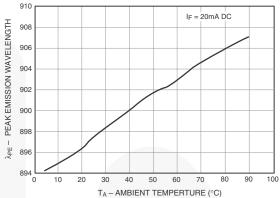
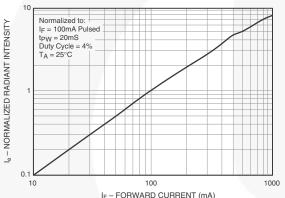


Figure 2. Peak Wavelength vs. Ambient Temperature



IF - FORWARD CURRENT (mA)

Figure 3. Normalized Radiant Intensity vs.

Forward Current

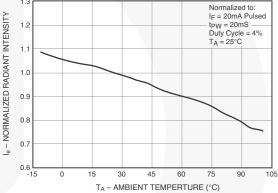


Figure 4. Normalized Radiant intensity vs.

Ambient Temperature

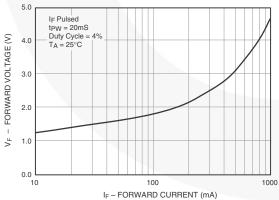


Figure 5. Forward Voltage vs. Forward Current

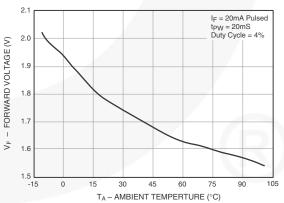


Figure 6. Forward Voltage vs. Ambient Temperature

Typical Performance Characteristics (Continued)

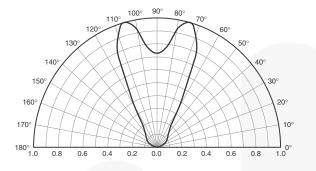


Figure 7. Radiation Diagram

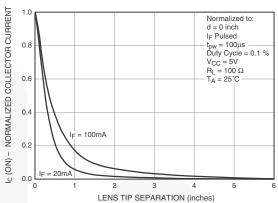


Figure 8. Coupling Characteristics of QEE122 and QSE113





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Definition of Terms					
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